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## N-Channel SuperFET<sup>®</sup> II MOSFET

## 600 V, 52 A, 72 m $\Omega$

#### Features

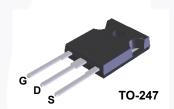
- 650 V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 66 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 95 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 421 pF)
- 100% Avalanche Tested
- RoHS Compliant

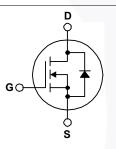
### Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies

## Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.





#### Absolute Maximum Ratings T<sub>C</sub> = 25<sup>o</sup>C unless otherwise noted.

Symbol		FCH072N60	Unit			
V <sub>DSS</sub>	Drain to Source Voltage	Drain to Source Voltage				
V <sub>GSS</sub>		- DC	- DC			
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	- V	
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		52	•	
		- Continuous (T <sub>C</sub> = 100	°C)	33	- A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	156	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			1128	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)			9.5	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)			4.8	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	(T <sub>C</sub> = 25°C)		W	
		- Derate Above 25°C		3.85	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

#### Thermal Characteristics

Symbol	Parameter	FCH072N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.26	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	-0/00

August 2014

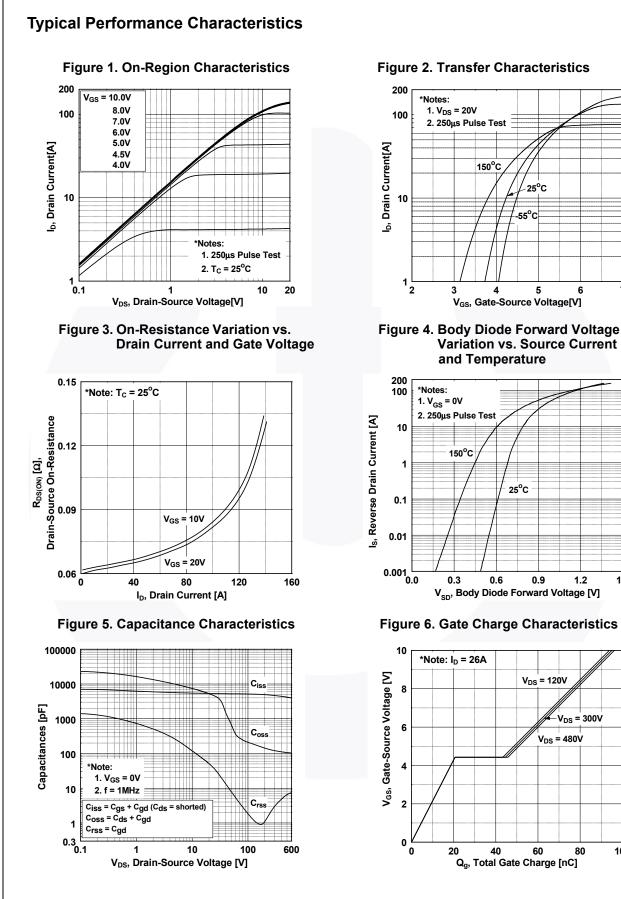
Symbol       Off Character       BV <sub>DSS</sub> D       △BV <sub>DSS</sub> B       / △T」     C       I <sub>DSS</sub> Z       I <sub>GSS</sub> G       On Character     G       V <sub>GS(th)</sub> G	Characteristics Paramet ristics Drain to Source Breakdow Breakdown Voltage Temp Coefficient Zero Gate Voltage Drain	T <sub>C</sub> = 25°C unless er wn Voltage	Test Conditi $V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}$		Min.	N/A Typ.	30 u Max.	units Unit
Symbol   Off Character   BV <sub>DSS</sub> D   ΔBV <sub>DSS</sub> B   / ΔT <sub>J</sub> C   I <sub>DSS</sub> Z   I <sub>GSS</sub> G   On Character   V <sub>GS(th)</sub> G	Paramet ristics Drain to Source Breakdow Breakdown Voltage Temp Coefficient Zero Gate Voltage Drain	er wn Voltage	Test Conditi $V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}$			Тур.	Max.	Unit
Off Character   BV <sub>DSS</sub> D   ΔBV <sub>DSS</sub> B   / ΔTJ C   I <sub>DSS</sub> Z   I <sub>GSS</sub> G   On Character   V <sub>GS(th)</sub> G	ristics Drain to Source Breakdow Breakdown Voltage Temp Coefficient Zero Gate Voltage Drain	wn Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 10 mA			Тур.	Max.	Unit
BV <sub>DSS</sub> D       ΔBV <sub>DSS</sub> B       / ΔT <sub>J</sub> C       I <sub>DSS</sub> Z       I <sub>GSS</sub> G       On Character     V <sub>GS(th)</sub>	Drain to Source Breakdow Breakdown Voltage Temp Coefficient Zero Gate Voltage Drain			T <sub>J</sub> = 25°C				
ΔΒV <sub>DSS</sub> B / ΔTJ C I <sub>DSS</sub> Z I <sub>GSS</sub> G On Character	Breakdown Voltage Temp Coefficient Zero Gate Voltage Drain			T <sub>J</sub> = 25°C				
ΔΒV <sub>DSS</sub> B / ΔTJ C I <sub>DSS</sub> Z I <sub>GSS</sub> G On Character	Breakdown Voltage Temp Coefficient Zero Gate Voltage Drain			0	600	-	-	V
/ ΔT J C I <sub>DSS</sub> Z I <sub>GSS</sub> G <b>On Character</b> V <sub>GS(th)</sub> G	Coefficient Zero Gate Voltage Drain	erature		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$		-	-	V
I <sub>GSS</sub> G On Character V <sub>GS(th)</sub> G	5		$I_D = 10$ mA, Referenced to $25^{\circ}C$		-	0.67	-	V/ºC
I <sub>GSS</sub> G On Character V <sub>GS(th)</sub> G	5	Current	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	1	μA
On Character	Sate to Body Leakage Cu	Guilent	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0	-	-	4.1	-	μΑ
V <sub>GS(th)</sub> G		Gate to Body Leakage Current		$V_{GS} = \pm 20 V, V_{DS} = 0 V$		-	±100	nA
	ristics							
	Sate Threshold Voltage		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μ.	A	2.5	-	3.5	V
R <sub>DS(on)</sub> S	Static Drain to Source On Resistance		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 26 A		-	66	72	mΩ
g <sub>FS</sub> F	Forward Transconductance		V <sub>DS</sub> = 20 V, I <sub>D</sub> = 26 A		-	48	-	S
Dynamic Cha	aracteristics							
-	nput Capacitance				-	4430	5890	pF
	Output Capacitance		V <sub>DS</sub> = 380 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	115	155	pF
	Reverse Transfer Capacit	ance			-	4.43	-	pF
	ffective Output Capacita	nce	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	421	-	pF
	otal Gate Charge at 10V		V <sub>DS</sub> = 380 V, I <sub>D</sub> = 26 A, V <sub>GS</sub> = 10 V (Note 4)		-	95	125	nC
Q <sub>gs</sub> G	Bate to Source Gate Cha	rge			-	21	-	nC
Q <sub>gd</sub> G	Bate to Drain "Miller" Cha	irge			-	24	-	nC
	quivalent Series Resista	ince	f = 1 MHz		-	0.93	-	Ω
Switchina Ch	naracteristics							
	urn-On Delay Time				-	33	76	ns
a(011)	urn-On Rise Time		$V_{DD}$ = 380 V, I <sub>D</sub> = 26 A, $V_{GS}$ = 10 V, R <sub>g</sub> = 4.7 Ω (Note 4)		/	23	56	ns
	urn-Off Delay Time				-	97	204	ns
u(011)	urn-Off Fall Time				-	3.5	17	ns
Drain-Sourco	Diode Characteri	etice		1		1		1
	aximum Continuous Dra		e Forward Current		-	-	52	A
3	laximum Pulsed Drain to				_	-	156	A
5101	rain to Source Diode Fo		$V_{GS} = 0 V$ , $I_{SD} = 26 A$		-	-	1.2	V
00	Reverse Recovery Time		$V_{GS} = 0 V, I_{SD} = 26 A,$		-	495	-	ns
	Reverse Recovery Charge		$V_{GS} = 0 V, I_{SD} = 26 A,$ $dI_{F}/dt = 100 A/\mu s$		-	13		μC

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2. I<sub>AS</sub> = 9.5 A, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C 3. I<sub>SD</sub> ≤ 26 A, di/dt ≤ 200 A/µs, V<sub>DD</sub> ≤ 380 V, Starting T<sub>J</sub> = 25°C

4. Essentially independent of operating temperature.

FCH072N60 — N-Channel SuperFET<sup>®</sup> II MOSFET



**Figure 2. Transfer Characteristics** 

25°C

5

0.9

V<sub>DS</sub> = 120V

60

1.2

V<sub>DS</sub> = 300V

80

V<sub>DS</sub> = 480V

1.5

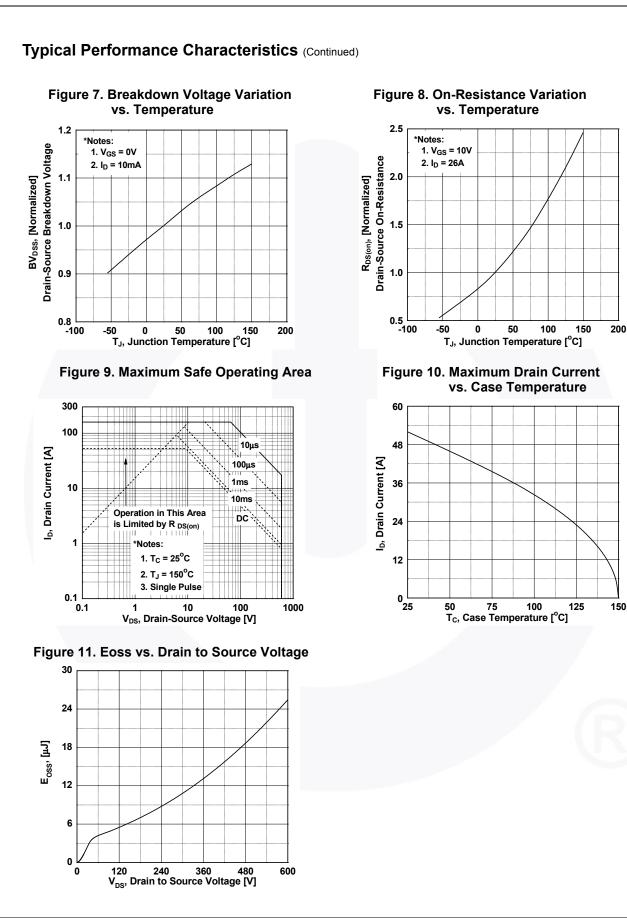
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7

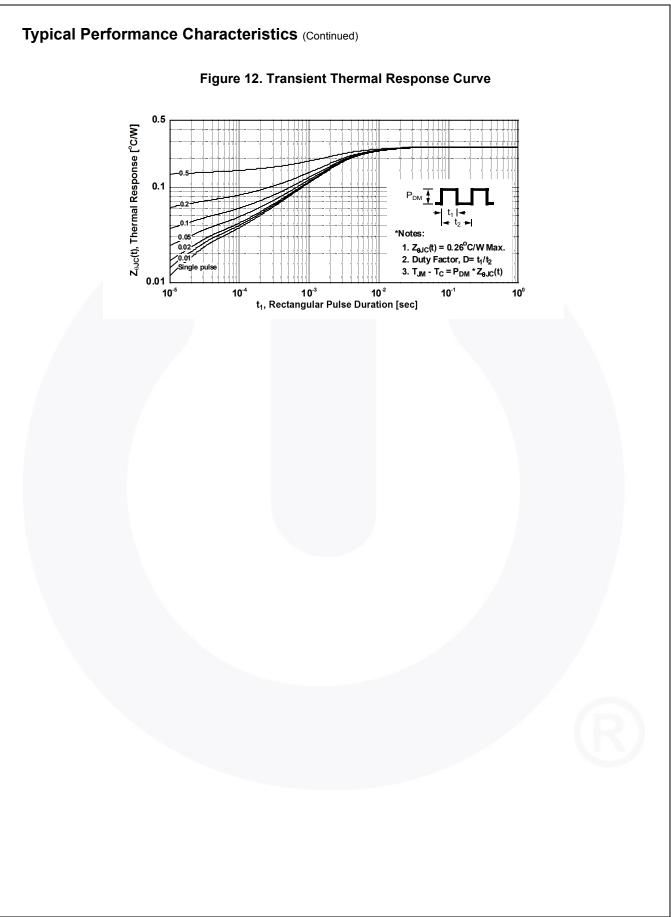
55°

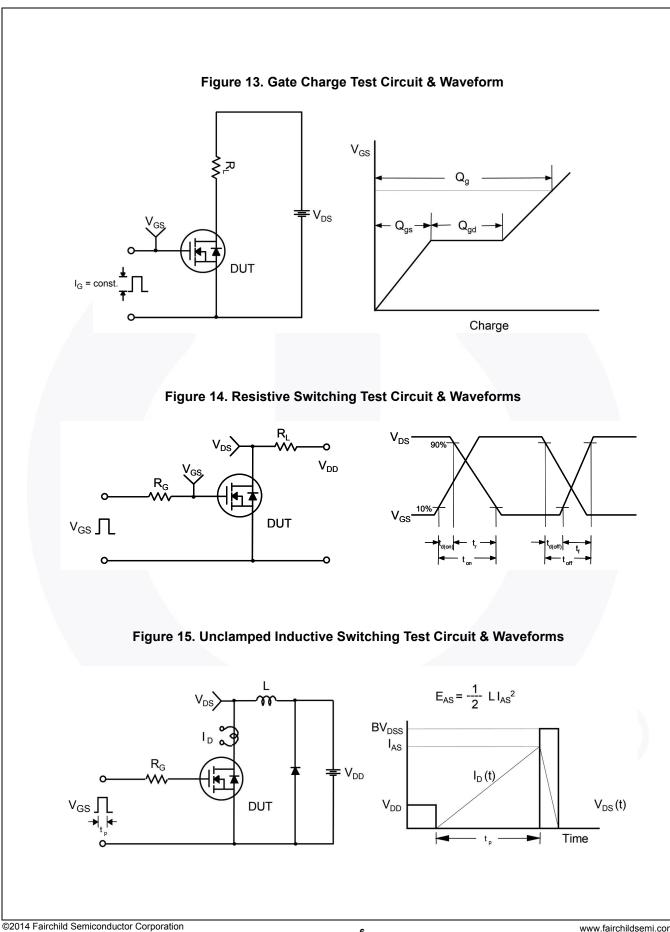
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4





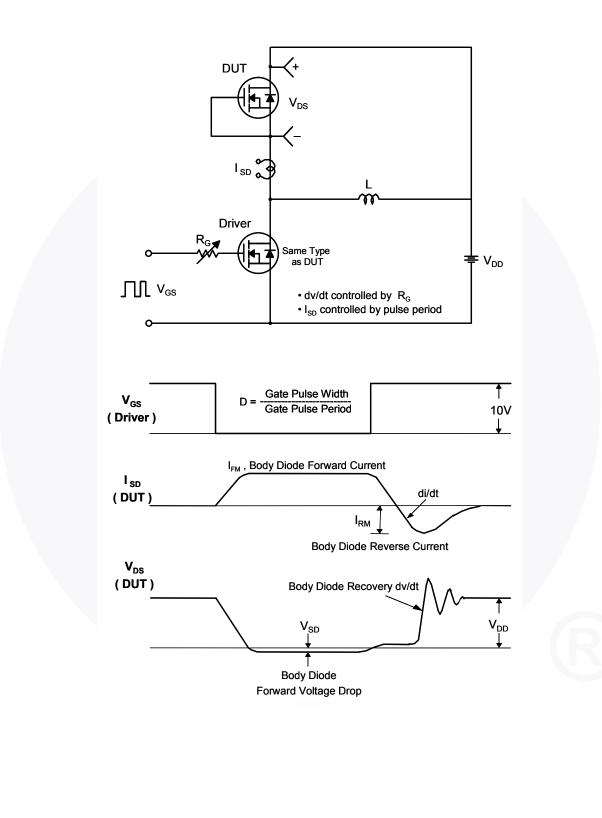
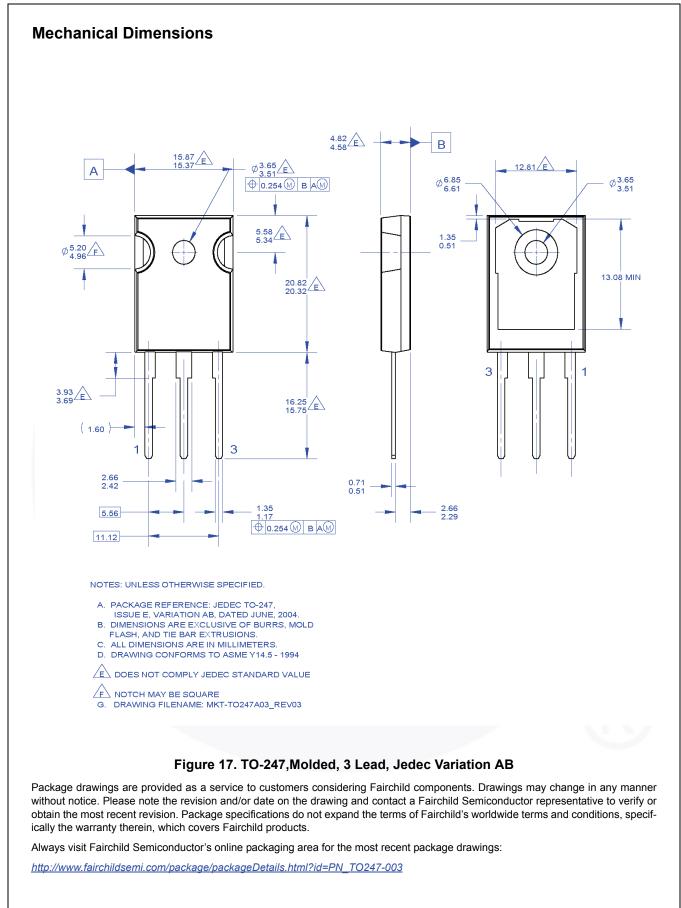


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms





Obsolete

Not In Production

Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 168

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